

Title (en)

Method for manufacturing inkjet printing head

Title (de)

Tintenstrahldruckkopfherstellungsverfahren

Title (fr)

Méthode de fabrication d'une tête d'impression à jet d'encre

Publication

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Application

EP 04015152 A 20040628

Priority

JP 2003188944 A 20030630

Abstract (en)

A method of manufacturing an inkjet printing head includes: forming a first laminated structure by laminating at least two metal plates having a hole formed thereon and fixing the metal plates to one another by metal-metal junction, and by laminating a plurality of thin plate members having a hole formed thereon, the thin plate members including the metal plates, and fixing the thin plate members to one another; forming a second laminated structure that includes at least a part of a common ink chamber, by laminating a plurality of thin plate members having a hole formed thereon and fixing the thin plate members to one another; and fixing the first laminated structure and the second laminated structure to each other while laminating the first laminated structure and the second laminated structure on each other.

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Citation (search report)

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